IPC ASSOCIATION CONNECTED ELECTRONICS INDUST	Material Compo © Copyright 2005. If international and Pan	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute					* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfg Information			
upplier Info	rmation														
Company name*			Company un	Company unique ID			Unique ID Authority				Respo	Response Date*			
nsemi										2024-0	2024-04-20				
Contact Name		Title - Contact			1	Phone - Contact*				Email	Email - Contact*				
Product-Env-Ste	wards		Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized Repr	esentative*	Title - Representative			1	Phone - Representative*				Email	Email - Representative*				
Product-Env-Ste	ewards	Product Envi	Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Reque	Requester Item Number Mfr Ite		em Number Mfr Item Name				Effective Dat	ctive Date Version Manufacturing Si		Manufacturing Site		Weight*	UOM	Unit Type	
		NCP6922	CP6922CDMTTXG 2 DCDC , 2 LDO Mini PMI		Mini PMIC		2024-04-20			MY1		41.88	mg	Each	
Ianufacturin	g Proccess Informat	ion						İ					·		
Terminal Plating / Grid Array Material To			Germinal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperatu		ire Max Time at Pea	k Temper	ature Numb	er of Reflow Cyc	eles			
Matte Tin (Sn) - annealed C			CU Alloy 1				260 C 30			seconds 3					
omments															
vel 1 - maximur	n time at peak temperatu	re during sol	dering is 10-3	0 seconds											
or more inform	ation regarding material	composition]	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier is liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.69	mg	Supplier	Silicon (Si)	7440-21-3		1.69	mg
Die Attach	0.18	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.0576	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.1224	mg
Lead Frame	18.45	mg	Supplier	Silver (Ag)	7440-22-4		0.1845	mg
			Supplier	Tin (Sn)	7440-31-5		0.0461	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0406	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0461	mg
			Supplier	Copper (Cu)	7440-50-8		18.1327	mg
Mold Compound-Black	20.8	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		1.664	mg
			Supplier	Carbon Black (C)	1333-86-4		0.104	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.416	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		17.992	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.624	mg
Plating	0.26	mg	Supplier	Tin (Sn)	7440-31-5		0.26	mg
Wire Bond - Au	0.5	mg	Supplier	Gold (Au)	7440-57-5		0.5	mg